

Description

The FMNS-1106S is a fast recovery diode of 600 V / $10\,$ A. The maximum t_{rr} of $100\,$ ns is realized by optimizing a life-time control.

Features

•	V _{RM}	600	V
•	I _{F(AV)}	10	A
•	V _F	- 1.3	V
•	t _{rr1}	100	ns

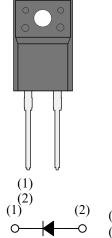
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

Applications

- PFC Circuit
- Freewheel Diode (Offline Buck and Buck-boost Converter)

Package

TO220F-2L



- (1) Cathode
- (2) Anode

Not to scale

FMNS-1106S

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V _{RSM}		600	V
Repetitive Peak Reverse Voltage	V_{RM}		600	V
Average Forward Current	I _{F(AV)}	See Figure 1 and Figure 2	10	A
Surge Forward Current	I _{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	100	A
I ² t Limiting Value	I ² t	$1 \text{ ms} \le t \le 10 \text{ ms}$	50	A^2s
Junction Temperature	T_{J}		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Formand Waltage Dream	V_{F}	$T_J = 25 ^{\circ}\text{C}, I_F = 10 \text{A}$	_	_	1.3	V
Forward Voltage Drop		$T_J = 100 ^{\circ}\text{C}, I_F = 10 \text{A}$		1.0		V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	_	_	100	μΑ
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_		10	mA
	t _{rr1}	$I_F = I_{RP} = 100 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$	_	_	100	ns
Reverse Recovery Time	t _{rr2}	$I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ $75\% \text{ recovery point},$ $T_J = 25 \text{ °C}$	_	_	50	ns
Thermal Resistance ⁽¹⁾	R _{th(J-C)}				4.0	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Heatsink Mounting Screw Torque		0.490	_	0.686	N·m
Package Weight		_	1.8		g

 $^{^{(1)}}R_{th\,(J\text{-}C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Derating Curves

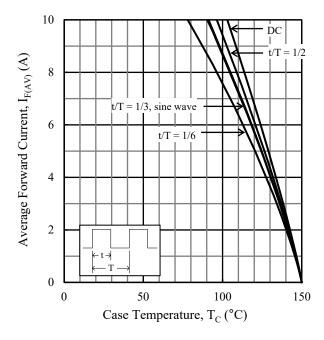


Figure 1. $I_{F(AV)}$ vs. T_C ($T_J = 150 \, ^{\circ}\text{C}$, $V_R = 0 \, \text{V}$)

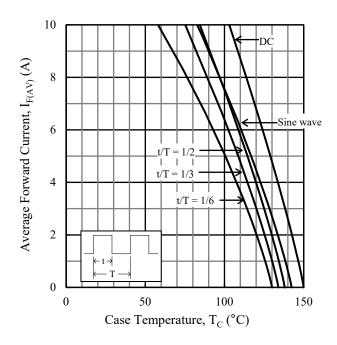


Figure 2. $I_{F(AV)}$ vs. T_C ($T_J = 150$ °C, $V_R = 600$ V)

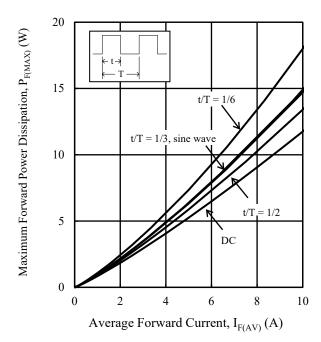


Figure 3. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

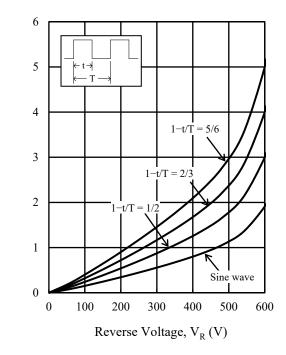
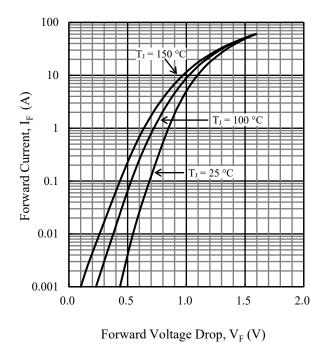


Figure 4. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

Maximum Reverse Power Dissipation, P_{R(MAX)} (W)

Characteristic Curves



1.E-03

1.E-03

1.E-04

1.E-05

1.E-05

1.E-06

1.E-07

0 100 200 300 400 500 600

Reverse Voltage, V_R (V)

Figure 5. Typical Characteristics: V_F vs. I_F

Figure 6. Typical Characteristics: V_R vs. I_R

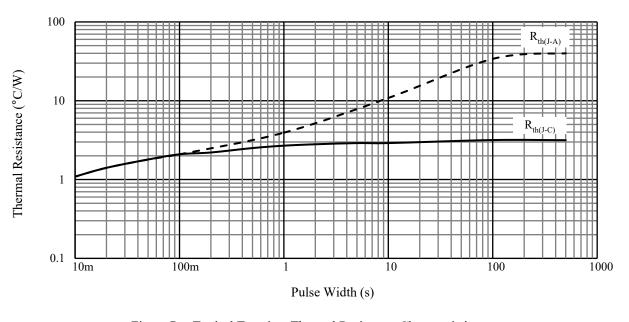
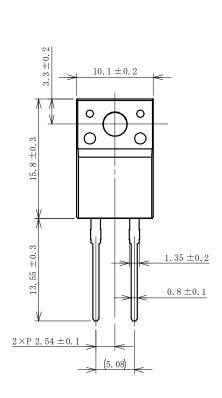
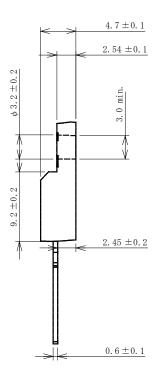


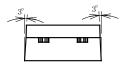
Figure 7. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• TO220F-2L







NOTES:

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: 270 °C / 7 s, 1 time

Soldering Iron: 350 °C / 3.5 s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram

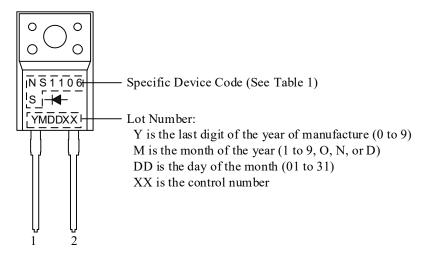


Table 1. Specific Device Code

Specific Device Code	Part Number		
NS1106S	FMNS-1106S		

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